Unit in: mm

TOSHIBA Phototransistor Silicon NPN Epitaxial Planar

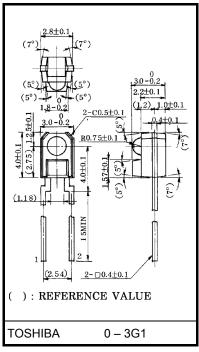
# **TPS622(F)**

Lead(Pb)-Free Opto-electronic Switch Optical Mouse Optical Touch Switch

- Compact side view epoxy resin package
- High response speed:  $t_r$ ,  $t_f = 6\mu s$  (typ.)
- Half value angle:  $\theta 1/2 = \pm 15^{\circ}$  (typ.)
- Visible light cut type (black package)
- Optimum in combination with infrared LED TLN117(F) with identical external dimensions.

## Absolute Maximum Ratings (Ta = 25°C)

Characteristic	Symbol	Rating	Unit
Collector-emitter voltage	V <sub>CEO</sub>	30	V
Emitter-collector voltage	V <sub>ECO</sub>	5	V
Collector current	IC	50	mA
Collector power dissipation	PC	75	mW
Collector power dissipation derating (Ta > 25°C)	ΔP <sub>C</sub> / °C	-1 mW / °0	
Operating temperature range	T <sub>opr</sub>	–25~85 °C	
Storage temperature range	T <sub>stg</sub>	-40~100 °C	
Soldering temperature (5s)	T <sub>sol</sub>	260 (Note 1)	°C



Weight: 0.1 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Soldering portion of lead: At least 2mm from the body of the device.

#### Opto-electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min.	Тур.	Max.	Unit
Dark current		I <sub>D</sub> (I <sub>CEO</sub> )	V <sub>CE</sub> = 24V, E = 0	_	0.005	0.1	μΑ
Light current		l∟	$E = 0.1 \text{mW} / \text{cm}^2$ , $V_{CE} = 3V$ (Note 2,3)	27	70	_	μΑ
Collector–emitter saturation voltage		V <sub>CE(sat)</sub>	$E = 0.1 \text{mW} / \text{cm}^2$ , $I_L = 15 \mu \text{A}$	_	0.15	0.4	٧
Peak sensitivity wavelength		λ <sub>P</sub>	_	_	870	_	nm
Half value angle		$\theta \frac{1}{2}$	_	_	±15	_	0
Switching time	Rise time	t <sub>r</sub>	$V_{CC} = 5V$ , $I_C = 2mA$ $R_L = 100\Omega$	_	6	_	μs
	Fall time	t <sub>f</sub>		_	6	_	

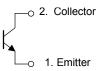


Note 2: Color temperature = 2870K standard tungsten lamp

Note 3: I<sub>L</sub> classification

Rank	I <sub>L</sub> (μΑ)
(A)	27~80
(B)	55~165
_	27min.

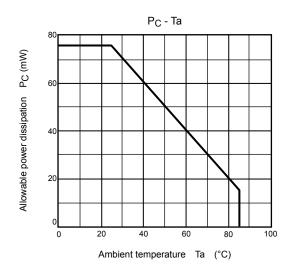
## **Pin Connection**

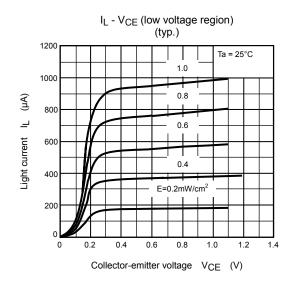


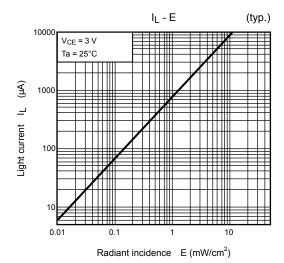
## **Precaution**

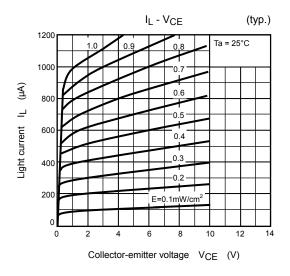
Take particular care with the following:

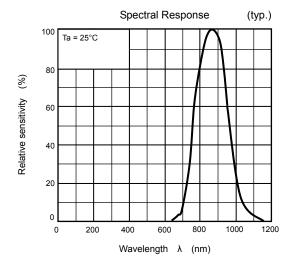
- 1. Lead forming should be carried out at least 2 mm from the body of the device without applying forming stress to the plastic.
  - Soldering should be performed after lead forming.

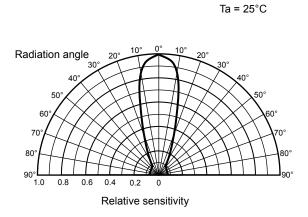












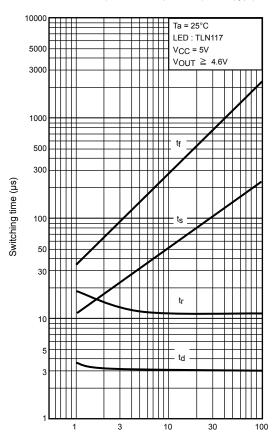
**Directional Sensitivity** 

(typ.)

Characteristic

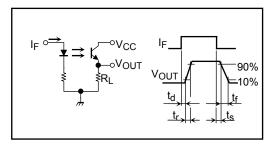
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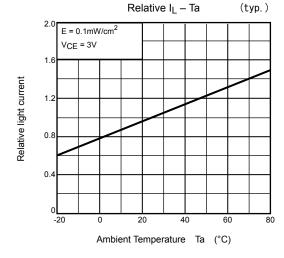
Switching Characteristics (saturated operation) (typ.)

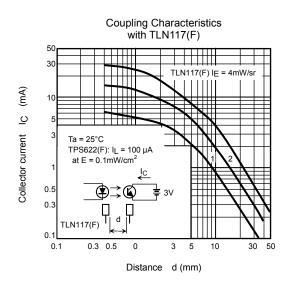


Load Resistance R<sub>L</sub>  $(k\Omega)$ 

Switching Time Test Circuit







4

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20070701-EN GENERAL

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